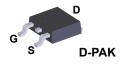


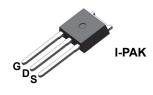
ON Semiconductor® FQD5N60C / FQU5N60C N-Channel QFET[®] MOSFET 600 V, 2.8 A, 2.5 Ω Features

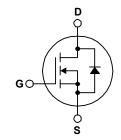
- + 2.8 A, 600 V, $R_{DS(on)}$ = 2.5 Ω (Max.) @ V_{GS} = 10 V, I_D = 1.4 A
- Low Gate Charge (Typ. 15 nC)
- Low Crss (Typ. 6.5 pF)
- 100% Avalanche Tested
- · RoHS compliant

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQD5N60CTM / FQU5N60CTU	Unit
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous (T _C = 25°C)		2.8	А
	- Continuous (T _C = 100°C)		1.8	А
I _{DM}	Drain Current - Pulsed	(Note 1)	11.2	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	210	mJ
I _{AR}	Avalanche Current	(Note 1)	2.8	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.9	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
	Power Dissipation (T _A = 25°C)*		2.5	W
PD	Power Dissipation (T _C = 25°C)		49	W
	- Derate above 25°C		0.39	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes,		300	°C
	1/8" from case for 5 seconds			0

Thermal Characteristics

Symbol	Parameter	FQD5N60CTM / FQU5N60CTU	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.56	
Р	Thermal Resistance, Junction-to-Ambient (minimum pad of 2 oz copper), Max.	110	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (* 1 in ² pad of 2 oz copper), Max.	50	

Device	Marking	Device	Package	Reel Size	Tape Width 16 mm		Quantity 2500 units	
FQD	5N60C	FQD5N60CTM	D-PAK	330 mm				
FQU	5N60C	FQU5N60CTU	I-PAK	Tube	Ν	I/A	70 units	
Electri	cal Char	acteristics T _C = 25°C	cunless otherwise	noted.				
Symbol		Parameter	Test C	onditions	Min	Тур	Max	Unit
Off Cha	aracteristi	cs						
BV _{DSS}	Drain-Sour	ce Breakdown Voltage	$V_{GS} = 0 V, I_D = 2$	50 μΑ	600			V
ΔBV_{DSS} / ΔT_{J}	Breakdowr Coefficient	Noltage Temperature	I_D = 250 µA, Referenced to 25°C			0.6		V/°C
	7	Valtana Dasia Oranast	V _{DS} = 600 V, V _G	_S = 0 V			1	μA
I _{DSS} Zero Ga		Voltage Drain Current	V _{DS} = 480 V, T _C	= 125°C			10	μA
I _{GSSF}	Gate-Body	Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body	Leakage Current, Reverse	V _{GS} = -30 V, V _{DS}	s = 0 V			-100	nA
On Cha	aracteristi	cs						
V _{GS(th)}	Gate Three	shold Voltage	$V_{DS} = V_{GS}, I_D = 2$	250 μΑ	2.0		4.0	V
R _{DS(on)}	Static Drain On-Resista		V_{GS} = 10 V, I _D =	1.4 A		2.0	2.5	Ω
		ansconductance	$V_{DS} = 40 \text{ V}, I_{D} =$	144		4.7		S

Dynamic C

Ciss	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,	 515	670	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	 55	72	pF
C _{rss}	Reverse Transfer Capacitance		 6.5	8.5	pF

Switching Characteristics

• • • • • • • • •	9					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 4.5A,		10	30	ns
t _r		$R_{G} = 25 \Omega$		42	90	ns
t _{d(off)}	Turn-Off Delay Time			38	85	ns
t _f	Turn-Off Fall Time	(Note		46	100	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 4.5A,		15	19	nC
Q _{gs}		V _{GS} = 10 V		2.5		nC
Q _{gd}	Gate-Drain Charge	(Note	e 4)	6.6		nC

Drain-Source Diode Characteristics and Maximum Ratings

Package Marking and Ordering Information

		•				
۱ _S	Maximum Continuous Drain-Source Die	Maximum Continuous Drain-Source Diode Forward Current			2.8	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				11.2	А
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.8 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 4.5 A,		300		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/µs		2.2		μC

NOTES:

1. Repetitive Rating : Pulse width limited by maximum junction temperature.

2. L = 18.9mH, I_{AS} = 4.5 A, V_{DD} = 50V, R_G = 25 Ω , starting T_J = 25°C.

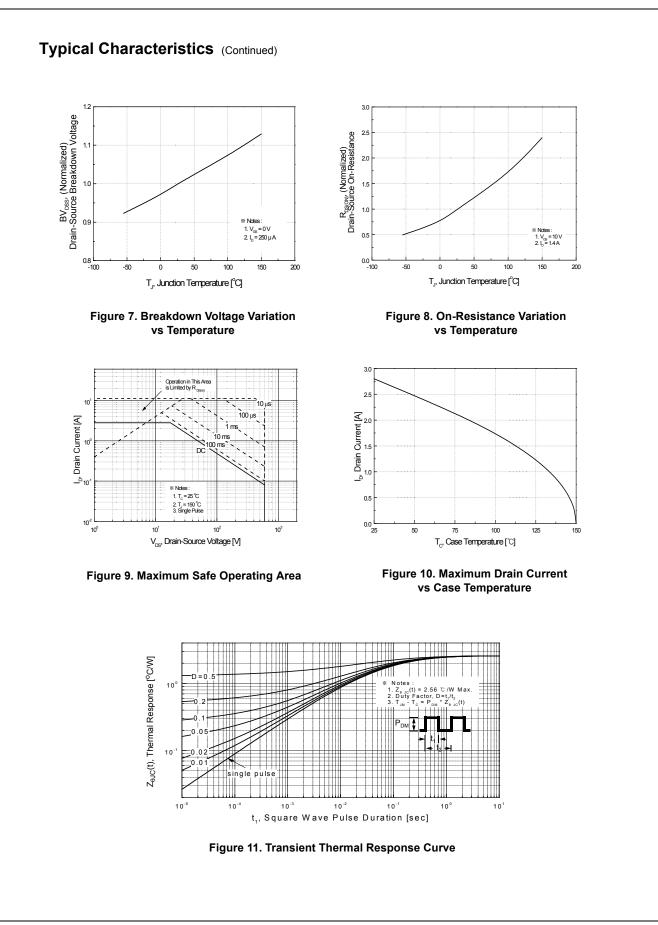
3. I_{SD} \leq 4.5A, di/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS_{\star}} starting T_J = 25°C.

4. Essentially independent of operating temperature.

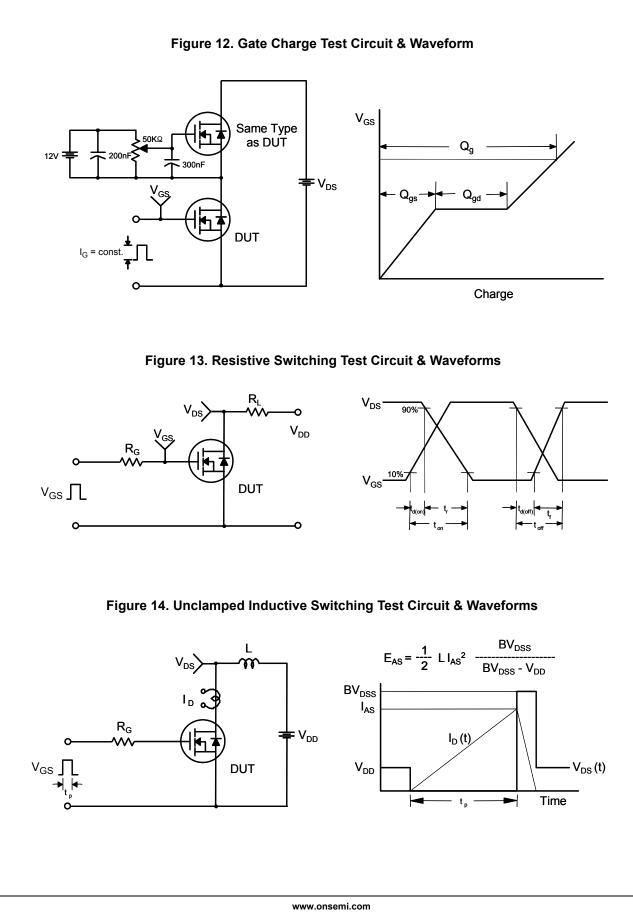
Typical Characteristics V 15.0 V 10.0 V 8.0 V 7.0 V 6.5 V 6.0 V 5.5 V 5.0 V 4.5 V 10¹ Top 10 I_b, Drain Current [A] I_D, Drain Current [A] 150°C 10 -55°C 10 W Notes : 1. 250µ s Pulse Tes 2. T_c = 25℃ Notes : 1. V_{DS} = 40V 2. 250µ s Pulse Test 10⁻¹ L 10⁻² 10⁻¹ 10[°] 10 V_{GS}, Gate-Source Voltage [V] V_{DS}, Drain-Source Voltage [V] **Figure 1. On-Region Characteristics** Figure 2. Transfer Characteristics 10 R_{bs(ov)} [Ω], Drain-Source On-Resistance 5 I_{DR}, Reverse Drain Current [A] V_{cs} = 10V 3 10 V_{GS} = 20V Notes : 1. V_{GS} = 0V 2. 250µ s Pulse Test ※ Note : T_i = 25℃ 10⁻¹ – 0.2 0 L 8 10 0.4 0.6 0.8 1.0 1.2 1.4 V_{sp}, Source-Drain voltage [V] I_D, Drain Current [A] Figure 3. On-Resistance Variation vs Figure 4. Body Diode Forward Voltage Drain Current and Gate Voltage Variation with Source Current and Temperature 1000 12 $C_{iss} = C_{gs} + C_{gd} (C_{ds} = sho)$ $C_{css} = C_{ds} + C_{gd}$ V_{DS} = 120V 800 Gate-Source Voltage [V] V_{DS} = 300V V_{DS} = 480V Capacitance [pF] 600 400 ₩ Notes; 1. V_{GS} = 0 V 2. f = 1 MHz 200 $<_{\rm GS'}$ 0 L 0 12 8 10⁰ 10 Q_G, Total Gate Charge [nC] V_{DS}, Drain-Source Voltage [V]



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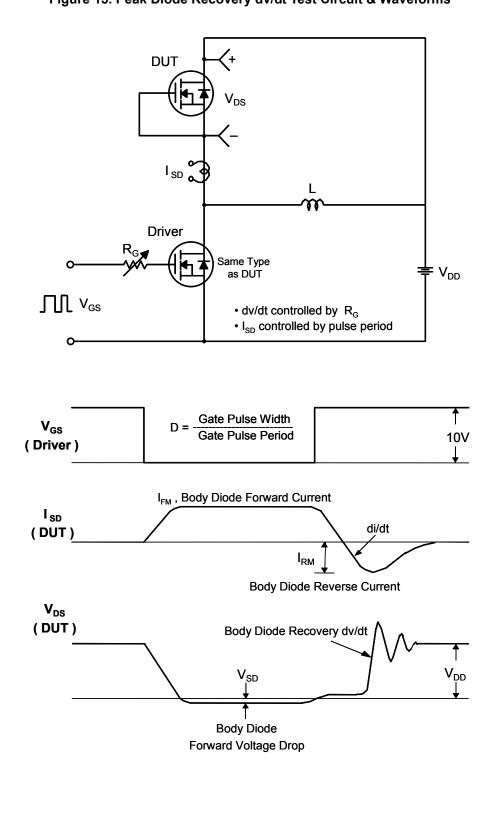
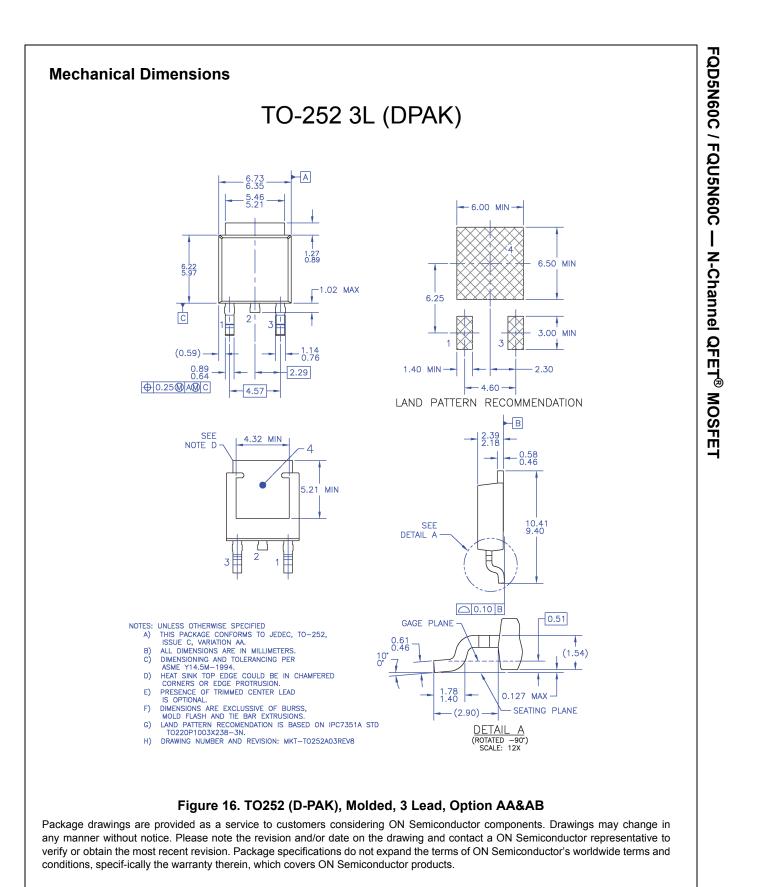
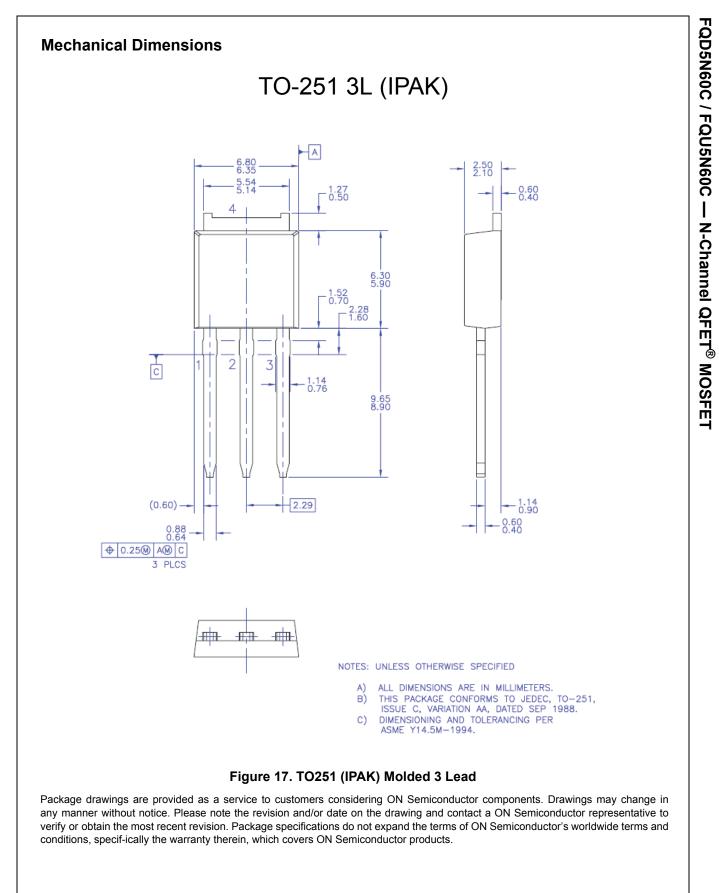


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Dimension in Millimeter



Dimension in Millimeters

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